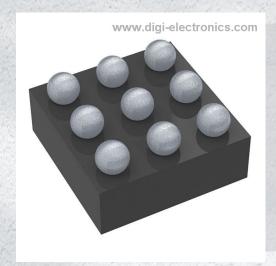


# FPF2496UCX Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number FPF2496UCX-DG

Manufacturer onsemi

Manufacturer Product Number FPF2496UCX

Description IC PWR LOAD SWITCH 9WLCSP

**Detailed Description** Power Switch/Driver 2.5A 9-WLCSP (1.22x1.22)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
FPF2496UCX	onsemi
Series:	Product Status:
IntelliMAX <sup>TM</sup>	Active
Switch Type:	Number of Outputs:
General Purpose	
Ratio - Input:Output:	Output Configuration:
Output Type:	Interface:
	On/Off
Voltage - Load:	Voltage - Supply (Vcc/Vdd):
3.5V ~ 5.5V	Not Required
Current - Output (Max):	Rds On (Typ):
2.5A	100mOhm
Input Type:	Features:
	Slew Rate Controlled, Status Flag
Fault Protection:	Operating Temperature:
Current Limiting (Adjustable), Over Temperature, Over Voltage, Revers	e-40rcen\$\$7CL(OA)
Mounting Type:	Supplier Device Package:
Surface Mount	9-WLCSP (1.22x1.22)
Package / Case:	Base Product Number:
9-UFBGA, WLCSP	FPF2496

# **Environmental & Export classification**

8542.39.0001

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



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April 2017

# FPF2496 IntelliMAX™ 28 V, Over-Voltage, Over-Current Protection Load Switch with Adjustable Current-Limit Control

#### **Features**

- VIN: 3.5 V~5.5 V
- 28 V Absolute Ratings at V<sub>IN</sub>
- Current Capability: 2.5 A
- Adjustable Current Limit: (Typ.) 0.1 A~2.5 A with 10% Accuracy
- R<sub>ON</sub>: Maximum 100 mΩ at 5 V<sub>IN</sub> and 1A I<sub>OUT</sub>
- Input OVP: Min.=5.6 V, Typ.=5.8 V, Max.=6 V
- Output Discharge During Off State
- Open-Drain OVP on FLAGB
- Thermal Shutdown
- Under-Voltage Lockout (UVLO)
- True Reverse-Current Blocking (TRCB)
- Logic CMOS IO Meets JESD76 Standard for GPIO Interface and Related Power Supply Requirements
- ESD Protected:
  - Human Body Model: >5.0 kV
  - Charged Device Model: >2.5 kV
  - IEC 61000-4-2 Air Discharge: >15 kV
  - IEC 61000-4-2 Contact Discharge: >8 kV

## **Applications**

- Smart Phones, Tablet PCs
- Storage, DSLR, and Portable Devices

# **Description**

The FPF2496 advanced load-management switch targets applications requiring a highly integrated solution. It disconnects loads powered from the DC power rail (<6 V) with stringent off-state current targets and high load capacitances (<100  $\mu F$ ). The FPF2496 consists of a slew-rate controlled low-impedance MOSFET switch (100 m $\Omega$  maximum) and integrated analog features. The slew-rate controlled turn-on characteristic prevents inrush current and the resulting excessive voltage droop on power rails. FPF2496 has over-voltage and over-temperature protection.

The FPF2496 has a True Reverse-Current Blocking (TRCB) function that obstructs unwanted reverse current from  $V_{\text{OUT}}$  to  $V_{\text{IN}}$  during ON and OFF states. The exceptionally low off-state current drain (<2  $\mu\text{A}$  maximum) facilitates compliance with standby power requirements. The input voltage range operates from 3.5 V to 5.5  $V_{\text{DC}}$  to support a wide range of applications in consumer, optical, medical, storage, portable, and industrial-device power management systems. Switch control is managed by a logic input (active LOW) capable of interfacing directly with low-voltage control signal / General-Purpose Input / Output (GPIO) without an external pull-down resistor.

The device is packaged in advanced, fully "green" compliant, 1.21 mm x 1.21 mm, Wafer-Level Chip-Scale Package (WLCSP).

## **Ordering Information**

Part Number	Operating Temperature Range	Package	Top Mark
FPF2496UCX	-40 to 85°C	1.21 mm x 1.21 mm, Wafer-Level Chip-Scale Package (WLCSP)	TJ

# **Application Diagram**

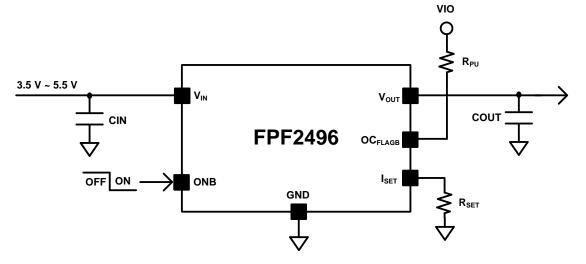


Figure 1. Typical Application

#### Note:

1. C<sub>IN</sub> and C<sub>OUT</sub> capacitors are recommended for improved device stability.

# **Block Diagram**

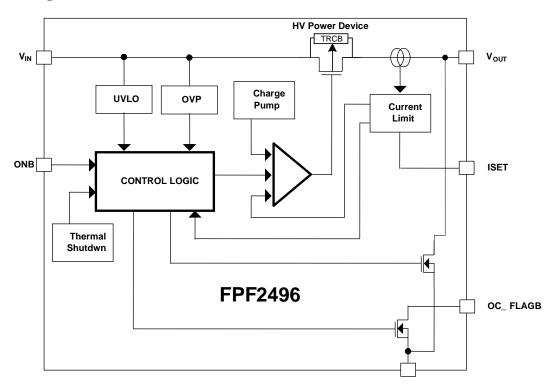
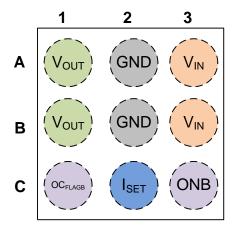


Figure 2. Functional Block Diagram

# **Pin Configurations**





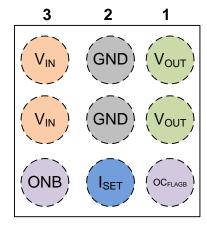


Figure 4. Pin Assignments (Bottom View)

# **Pin Description**

Pin#	Name	Description					
A1, B1	V <sub>OUT</sub>	Switch Output					
A3, B3	VIN	Supply Input: Input to the power switch					
A2	GND	Cround (Davisa Cround)	Description (Paris Construct)				
B2	GIND	Ground (Device Ground)					
Ca	ONB	ON/OFF Control Input: Active LOW: CRIO competible	Logic HIGH	Switch Disable			
C3	OIND	ON/OFF Control Input: Active LOW; GPIO compatible Logic LOW Switch Enable					
C1	C1 OC <sub>FLAGB</sub> Fault Output: Active LOW, open-drain output that indicates an input over current. External pull-up resistor to V <sub>CC</sub> is required.						
C2	C2 I <sub>SET</sub> Current Limit Set Input: A resistor from ISET to ground sets the current limit for the switch.						

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters			Max.	Unit	
V	Vin to GND, Vin to Vout		-0.3	28.0	V	
V PIN	V <sub>PIN</sub> ONB, V <sub>OUT</sub> , FLAGB, I <sub>SET</sub> to GND		-0.3	6.0	V	
Isw	Maximum Continuous S	witch Current		2.75	Α	
t <sub>PD</sub>	Total Power Dissipation	at T <sub>A</sub> =25°C		1.0	W	
TJ	Operating Junction Tem	perature	-40	+150	°C	
T <sub>STG</sub>	Storage Junction Temperature		-65	+150	°C	
0	Thermal Resistance, Junction-to-Ambient			95 <sup>(2)</sup>	°C/W	
ΘЈА	(1-inch Square Pad of 2	oz. Copper)		110(3)	C/VV	
	Electrostatic Discharge	Human Body Model, ANSI/ESDA/JEDEC JS-001-2012	5.0			
ESD	Capability	Charged Device Model, JESD22-C101	2.5		kV	
	IEC61000-4-2 System	Air Discharge (V <sub>IN</sub> , V <sub>ON</sub> , V <sub>OUT</sub> to GND)	15			
	Level	Contact Discharge (VIN, VON, VOUT to GND)	8			

#### Notes:

- 2. Measured using 2S2P JEDEC std. PCB.
- 3. Measured using 2S2P JEDEC PCB cold plate method.

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameters	Min.	Max.	Unit
VIN	Supply Voltage	3.5	5.5	V
T <sub>A</sub>	Ambient Operating Temperature	-40	85	°C

## **Electrical Characteristics**

Unless otherwise noted; V<sub>IN</sub>=3.5 to 5.5 V, T<sub>A</sub>=-40 to +85°C; typical values are at V<sub>IN</sub>=5 V and T<sub>A</sub>=25°C.

Symbol	Parameters	Condition	Min.	Тур.	Max.	Unit
Basic Oper	ation		1			I.
V <sub>IN</sub>	Input Voltage		3.5		5.5	V
I <sub>Q(OFF)</sub>	Off Supply Current	Vonb=HIGH, Vout=Open		1	2	μΑ
I <sub>SD(OFF)</sub>	Shutdown Current	V <sub>IN</sub> =5.5 V, V <sub>OUT</sub> =0 V, V <sub>ONB</sub> =HIGH		0.1	4.0	μΑ
Ιq	Quiescent Current	Iouт=0 mA		65	100	μΑ
Б	On Basistana	V <sub>IN</sub> =5.0 V, I <sub>OUT</sub> =1 A		70	100	0
Ron	On Resistance	V <sub>IN</sub> =3.7 V, I <sub>OUT</sub> =1 A		75	105	mΩ
VIH	ONB Input Logic HIGH Voltage	V <sub>IN</sub> =3.5 V to 5.5 V	1.15			V
VIL	ONB Input Logic LOW Voltage	V <sub>IN</sub> =3.5 V to 5.5 V			0.65	V
M	FLAGB Output Logic	V <sub>IN</sub> =5 V, I <sub>SINK</sub> =10 mA		0.1	0.2	.,
VIL_FLAG	LOW Voltage	V <sub>IN</sub> =3.5 V, I <sub>SINK</sub> =10 mA		0.15	0.30	V
I <sub>FLAGB_LK</sub>	FLAGB Output HIGH Leakage Current	V <sub>IN</sub> =5 V, Switch On			1	μΑ
I <sub>ON</sub>	ONB Input Leakage	0 V to V <sub>IN</sub>			1.0	μA
R <sub>ON_PD</sub>	Pull-Down Resistance at ONB Pin	V <sub>IN</sub> =3.5~5.5 V, V <sub>ON</sub> =HIGH, T <sub>A</sub> =-40 to 85°C		14		МΩ
RPD	Output Discharge RPULL_DOWN	V <sub>IN</sub> =3.5 V, V <sub>ONB</sub> =HIGH, I <sub>FORCE</sub> =20 mA, T <sub>A</sub> =-40 to 85°C		100		Ω
Over-Voltaç	ge Protection		-			•
	1.00/15.1	V <sub>IN</sub> Rising Threshold	5.60	5.80	6.00	.,
V <sub>OVP_TRIP</sub>	Input OVP Lockout	V <sub>IN</sub> Falling Threshold		5.50		V
V <sub>OVP_HYS</sub>	Input OVP Hysteresis			0.3		V
tovp	Response Time	I <sub>OUT</sub> =0.5 A, C <sub>L</sub> =1 μF, T <sub>A</sub> =25°C, V <sub>IN</sub> =5.5 V to 6.0 V	1			μs
Over-Curre	nt Protection					•
	Commont Limit	$V_{\text{IN}=5}$ V, $R_{\text{SET}}$ = 2100 $\Omega$ , $V_{\text{OUT}}$ >1.68V with with 10% Accuracy	450	500	550	- mA
ILIM	Current Limit	$V_{\text{IN}=5}$ V, $R_{\text{SET}}$ = 1070 $\Omega$ , $V_{\text{OUT}}$ >1.68 V with 10% Accuracy	900	1000	1100	
	Llada Valta va Ladrovt	V <sub>IN</sub> Increasing		3.2		.,
$V_{UVLO}$	Under-Voltage Lockout	V <sub>IN</sub> Decreasing		3.0		V
Vuvlo_Hys	UVLO Hysteresis			200		mV
$V_{T\_RCB}$	RCB Protection Trip Point	V <sub>OUT</sub> - V <sub>IN</sub>		50		mV
V <sub>R_RCB</sub>	RCB Protection Release Trip Point	Vin - Vout		50		mV

Continued on the following page...

## **Electrical Characteristics** (Continued)

Unless otherwise noted;  $V_{IN}=3.5$  to 5.5 V,  $T_A=-40$  to  $+85^{\circ}C$ ; typical values are at  $V_{IN}=5$  V and  $T_A=25^{\circ}C$ .

Symbol	Parameters	Conditions	Min.	Тур.	Max.	Unit	
V <sub>RCB_HYS</sub>	RCB Hysteresis			100		mV	
t <sub>RCB</sub>	Default RCB Response Time	V <sub>IN</sub> =5 V, V <sub>ONB</sub> =HIGH/LOW		2		μs	
I <sub>RCB</sub>	RCB Current	V <sub>ONB</sub> =HIGH, V <sub>OUT</sub> =5.5 V		14		μA	
tHOCP	Hard Over-Current Response Time	Moderate Over-Current Condition, I <sub>OUT</sub> ≥ I <sub>LIM</sub> , V <sub>OUT</sub> ≤ 0 V		6		μs	
tocp	Over-Current Response Time	Moderate Over-Current Condition, $I_{OUT} \ge I_{LIM} V_{OUT} \le V_{IN}$		7		μs	
toc_flag	Over-Current Flag Response Time	When Over-Current Occurs to Flag Pulling LOW				ms	
		Shutdown Threshold		150			
TSD	Thermal Shutdown	Return from Shutdown		130		°C	
		Hysteresis		20	20		
Dynamic C	haracteristics						
t <sub>DON</sub>	Turn-On Delay(4,5)			4.39		ms	
t <sub>R</sub>	V <sub>OUT</sub> Rise Time <sup>(4,5)</sup>			7.26		ms	
ton	Turn-On Time(4,7)	V 5 V D 400 O C 4 v 5 T 25°C		11.65		ms	
tDOFF	Turn-Off Delay(5)	$V_{IN}$ =5 V, R <sub>L</sub> =100 Ω, C <sub>L</sub> =1 μF, T <sub>A</sub> =25°C		1.85		ms	
t <sub>F</sub>	V <sub>OUT</sub> Fall Time <sup>(5)</sup>			37.60		ms	
toff	Turn-Off Time(7)			39.45		ms	

#### Notes:

- 4. This parameter is guaranteed by design and characterization; not production tested.
- 5. t<sub>DON</sub>/t<sub>DOFF</sub>/t<sub>R</sub>/t<sub>F</sub> are defined in Figure 5 below.
- 6.  $t_{ON}=t_R + t_{DON}$ .
- 7.  $t_{OFF}=t_F+t_{DOFF}$ .

# **Timing Diagram**

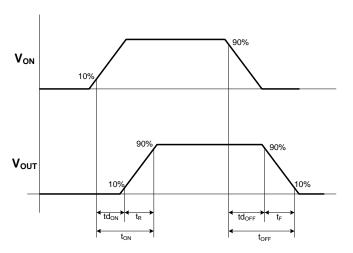


Figure 5. Timing Diagram

#### where:

$$\begin{split} &t_{DON} = Delay \ On \ Time \\ &t_{R} = V_{OUT} \ Rise \ Time \\ &t_{ON} = Turn-On \ Time \\ &t_{DOFF} = Delay \ Off \ Time \\ &t_{F} = V_{OUT} \ Fall \ Time \\ &t_{OFF} = Turn \ Off \ Time \end{split}$$

## **Operation and Application Description**

#### **Input Capacitor**

To limit the voltage drop on the input supply caused by transient inrush current when the switch turns on into discharge load capacitor; a capacitor must be placed in between the  $V_{\text{IN}}$  and GND pins. A high-value  $C_{\text{IN}}$  capacitor can be used to reduce the voltage drop in high-current applications.

#### **Output Capacitor**

An output capacitor should be placed between the  $V_{\text{OUT}}$  and GND pins. This capacitor prevents parasitic board inductance from forcing  $V_{\text{OUT}}$  below GND when the switch is on. This capacitor also prevents reverse inrush current from creating a voltage spike that could damage the device in the case of a  $V_{\text{OUT}}$  short.

#### **Fault Reporting**

Upon the detection of an over-current, OC\_FLAGB signals the fault by activating LOW.

#### **Current Limiting**

The current limit ensures that the current through the switch does not exceed the maximum set value, while not limiting the minimum value. The current limit is adjustable through the selection of an external resistor connected to ISET. Information for selecting the resistor is found in the sections below. The device acts as a constant-current source when the load draws more than the maximum value set by the device until thermal shutdown occurs. The device recovers if the die temperature drops below the threshold temperature.

#### **Under-Voltage Lockout (UVLO)**

The under-voltage lockout turns the switch off if the input voltage drops below the lockout threshold. With the ONB pin active, the input voltage rising above the UVLO threshold releases the lockout and enables the switch.

#### **True Reverse-Current Blocking**

The true reverse-current blocking feature protects the input source against current flow from output to input, whether the load switch is on or off.

#### Thermal Shutdown

The thermal shutdown protects the die from internally or externally generated excessive temperature. During an over-temperature condition, the switch is turned off. The switch automatically turns on again if the temperature of the die drops below the threshold temperature.

#### **Setting Current Limit**

The current limit is set with an external resistor connected between the  $I_{\text{SET}}$  and GND pins. The resistor is selected using Table 1. Resistor tolerance of 1% or less is recommended

Table 1. Current Limit Settings by RSET<sup>(8)</sup>

$R_{SET}\Omega$	Min. Current Limit (mA)	Typ. Current Limit (mA)	Max. Current Limit (mA)
420	2250	2500	2750
469	2020	2250	2407
528	1800	2000	2200
604	1570	1750	1920
680	1350	1500	1650
866	1125	1250	1375
1070	900	1000	1100
1200	810	900	990
1330	720	800	880
1500	630	700	770
1740	540	600	660
2100	450	500	550
2320	405	450	495
2550	360	400	440
2940	315	350	385
3400	370	300	330
4020	225	250	275
4990	180	200	220
6490	135	150	165
9530	90	100	110

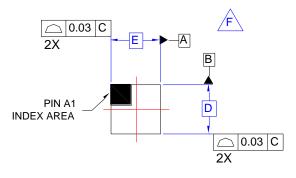
#### Note:

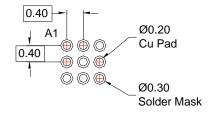
8. Table values based on 1% tolerance resistor.

#### **Board Layout**

For best performance, all traces should be as short as possible. The input and output capacitors should be placed close to the device to minimize the effect that parasitic trace inductance may have on normal and short-circuit operation. Using wide traces for  $V_{\text{IN}}$ ,  $V_{\text{OUT}}$ , GND helps minimize parasitic electrical effects along with minimizing the case-to-ambient thermal impedance.

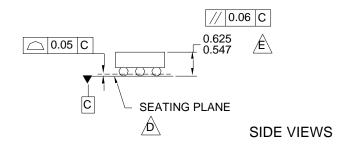
# **Physical Dimensions**

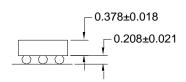


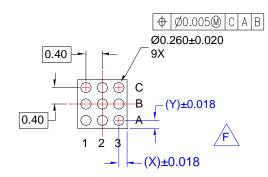


**TOP VIEW** 

LAND PATTERN RECOMMENDATION (NSMD PAD TYPE)







**BOTTOM VIEW** 

#### NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 1994.
- D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 586 MICRONS ±39 MICRONS (547-625 MICRONS).



G. DRAWING FILNAME: MKT-UC009ABrev2

#### **Product-Specific Dimensions**

Product	D	E	X	Y
FPF2496	1210 µm ±30 µm	1210 μm ±30 μm	205 μm	205 μm

FPF2496 — IntelliMAX™ 28 V Over-Voltage, Over-Current Protection Load Switch with Adjustable Current Limit Contro

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